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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT ECKMILLER, ROLF ET AL.
TITLE MICROCONTACT STRUCTURE FOR NEUROPROSTHESES
FOR IMPLANTATION ON NERVE TISSUE AND METHOD
THEREFOR
FILING DATE Herewith

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Honorable Assistant Commissioner of Patents and Trademarks, Box Patent Applications, Washington, D.C. 20231

Date of Deposit: Jan. 26, 2001

Name: Richard C. Woodbridge

Signature

Richard C. Woodbridge

Date of Signature: Jan 26, 2001

HONORABLE ASSISTANT COMMISSIONER OF PATENTS
BOX PATENT APPLICATIONS
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PRELIMINARY AMENDMENT

Dear Sir:

Preliminary to a First Office Action on the merits of this application please amend the application as follows:

IN THE SPECIFICATION:

Page 3, line 25 please add the following:

BRIEF DESCRIPTION OF THE DRAWINGS

Figs. 1a-1c illustrate the manner in which the microcontact structure can be folded.

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Fig. 1d illustrates the manner in which the folded structure can be clamped in place.